Fast Recovery Diode Stud
Types M0268S/RX200 to M0268S/RX250

The data sheet on the subsequent pages of this document is a scanned copy of existing data for this product.
(Rating Report 90NR10 Issue 2)

This data reflects the old part number for this product which is: SM16-25PCN/R134.
This part number must **NOT** be used for ordering purposes – please use the ordering particulars detailed below.

The limitations of this data are as follows:
Only S/RC outline drawing (W22) in datasheet
Some reverse recovery data missing
Device no longer available for grades 16 & 18 (1600V & 1800V V_{RRM})

The following links will direct you to the appropriate outline drawings
Outline W22 – ½" Ceramic stud and lug
Outline W24 – ¾" Ceramic stud

Where any information on the product matrix page differs from that in the following data, the product matrix must be considered correct

An electronic data sheet for this product is presently in preparation.

For further information on this product, please contact your local ASM or distributor.

Alternatively, please contact Westcode as detailed below.

Ordering Particulars			
M0268	S/RX	♦♦	**0**
Fixed Type Code	S/RC – ¾" Ceramic stud S/RJ – ½" Ceramic stud and lug	Voltage code V_{RRM}/100 20-25	Fixed Code
Typical Order Code: M0268SC200, Normal polarity ¾" Ceramic stud, 2000V V_{RRM}			

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QUALITY EVALUATION LABORATORY

Rating Report No: 90NR10 (Issue 2) Date: 4th March, 1993

Origin: Q.E.L. Pages: 26

Stud Based Diode SM16-25PCN/R134

Written by: M. Baker Checked: M.J. Perry Approved:

The SMxxPCN/R134 series of diffused, fast recovery diodes are based on a 24 mm diameter silicon mounted under spring pressure in a stud base housing.

These diodes are particularly suitable to use in G.T.O. snubber networks.

This supersedes 90NR10 (Issue 1) dated 28.6.90.

Ratings

Voltage Grades	: 16-25
V_{RSM}	: 1700-2600V
V_{RRM}	: 1600-2500V
$I_{F(AV)}$ Single phase: 50 Hz 180° half sinewave; T_{CASE} = 100°C	: 120A
$I_{F(rms)}$ max.	: 400A
I_F max.	: 400A
I_{FSM} : t = 10ms half sinewave; T_J (initial) = 125°C $V_{RM} = 0.6V_{RRM(MAX)}$	: 4250A
I_{FSM} : t = 10ms half sinewave; T_J (initial) = 125°C $V_{RM} \leq 10V$	: 4670A
I^2t : t = 10ms T_J (initial) = 125°C; $V_{RM} = 0.6V_{RRM(MAX)}$	: 90.3 x 10^3A^2S
I^2t : t = 10ms; T_J (initial) = 125°C; $V_{RM} \leq 10V$	: 109 x 10^3A^2S
I^2t : t = 3ms; T_J (initial) = 125°C; $V_{RM} \leq 10V$	: 80.6 x 10^3A^2S
T_{CASE} Operating Range	: -40 to +125°C
T_{stg} : Non-operating	: -40 to +150°C

R.R. No.	90NR10
R.R. Issue	2
Page Issue	1

Characteristics
(Maximum values unless otherwise stated)

V_o :	: 1.21V
r_s :	: 1.2mohms
A : T_J = 25°C	: 0.5115
B : T_J = 25°C	: 0.2148
C : T_J = 25°C	: 9.468×10^{-4}
D : T_J = 25°C	: -2.1073×10^{-2}
A	: -2.7312
B	: 1.0775
C	: 2.2052×10^{-3}
D	: -0.1451
V_{FM} at I_{FM} = 470A	: 1.77V
$R_{th(J-C)}$	: 0.13 K/W
$R_{th(C-HS)}$	: 0.04 K/W
I_{RRM} : at $V_{RRM(MAX)}$	: 20mA
V_{fr} : at dI/dt = 400A/μS	: 37V (typical)

Reverse recovery at I_{FM} = 1KA; t_p = 200μs
di_R/dt = 150A/uS; V_{RM} = 50V

Q_{RR} (total area)	: 350μC
Q_{RA} (50% chord)	: 230μC
t_{rr} (50% chord)	: 2.8μS (typical)
I_{RM}	: 160A
Mounting Force	: 14Nm
Outline Drawing	: 100A297
JEDEC Outline No.	: -

NOTE: All characteristics are at T_{VJ} = T_{Jmax} operating unless stated otherwise.

CONTENTS

Voltage Ratings

Voltage Class	V_{RRM} V	V_{RSM} V
16	1600	1700
18	1800	1900
20	2000	2100
22	2200	2300
24	2400	2500
25	2500	2600

This Report is applicable to higher or lower voltage grades when supply has been agreed by Sales/Production.

2.0 Introduction

The diode series comprises fast recovery stud based devices with all diffused silicon slices. All these diodes have controlled reverse recovery characteristics with good "K" factors. These diodes are particularly suitable for use in G.T.O. and SCR snubber networks.

3.0 Notes on the Ratings

(a) Square wave ratings

These ratings are given for leading edge linear rates of rise of forward current of 400 and 800A/uS.

(b) Energy per pulse characteristics

These curves enable rapid estimation of device dissipation to be obtained for conditions not covered by the frequency ratings.

Let: Ep be the Energy per pulse for a given current and pulse width in joules, and f be the repetition rate

Then $W_{AV} = Ep \times f$

$$T_{CASE} = T_{J(MAX)} - Ep \times f \times R_{th}$$

(c) Housing Loss

The loss caused by coupling between housing and anode current (which gives rise to additional heating at high frequency) has been incorporated into the curves of forward energy loss per pulse.

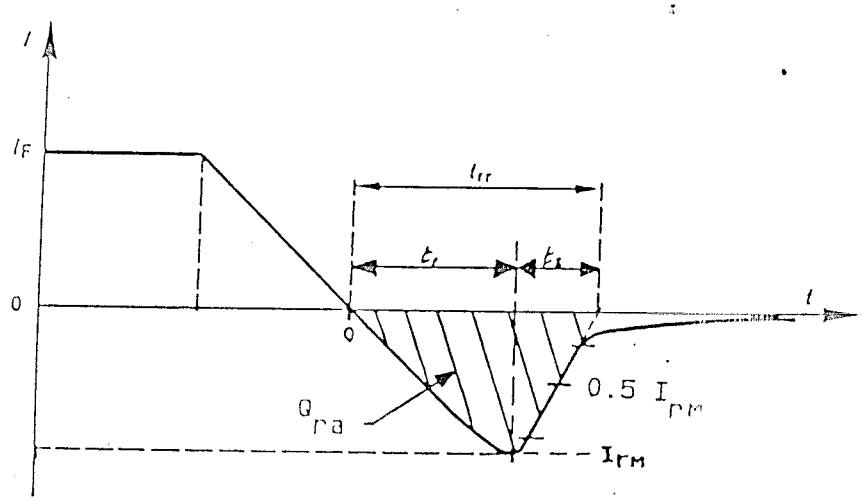
(d) ABCD Constants

These constants are the co-efficients of the semi-empirical expression for the forward characteristic given below:

$$V_F = A + B \ln I_F + C I_F + D \sqrt{I_F}$$

(e) Reverse recovery ratings

(i) Q_{ra} is based on 50% I_{rm} chord as shown below



(ii) Q_{rr} is based on a 150 uS integration time

$$\text{i.e. } Q_{rr} = \int_{t=0}^{150uS} I_r \, . \, dt$$

(iii) K factor = t_1/t_2

4.0 Reverse Recovery Loss

The following procedure is recommended for use where it is necessary to include reverse recovery loss.

(i) Determination by measurement

From waveforms of recovery current obtained from a high frequency shunt (see Note 1) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform by A joules per pulse. A new case temperature can then be evaluated from:

$$T_{CASE}(new) = T_{CASE}(original) - A\left(\frac{r_t \cdot 10^6}{t} + R_{th} \times f\right)$$

where $r_t = 1.77 \times 10^{-4} \cdot \sqrt{t}$

t = duration of reverse recovery loss per pulse in microseconds

A = Area under reverse loss waveform per pulse in joules (W.S.)

f = rated frequency at the original case temperature

The total dissipation is now given by

$$W_{(TOT)} = W_{(original)} + Axf$$

NOTE 1

Reverse Recovery Loss by Measurement

This device has a low reverse recovered charge and peak reverse recovery current. When measuring the charge care must be taken to ensure that:

(a) a.c. coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.

(b) The measuring oscilloscope has adequate dynamic range - typically 100 screen heights - to cope with the initial forward current without overload.

(c) Measurement of reverse recovery waveform should be carried out with an appropriate snubber of 0.1uF, 5ohms connected across diode anode to cathode.

(ii) Design Method

In circumstances where it is not possible to measure voltage and current conditions, or for design purposes, the additional losses may be estimated from curves on pages 16.

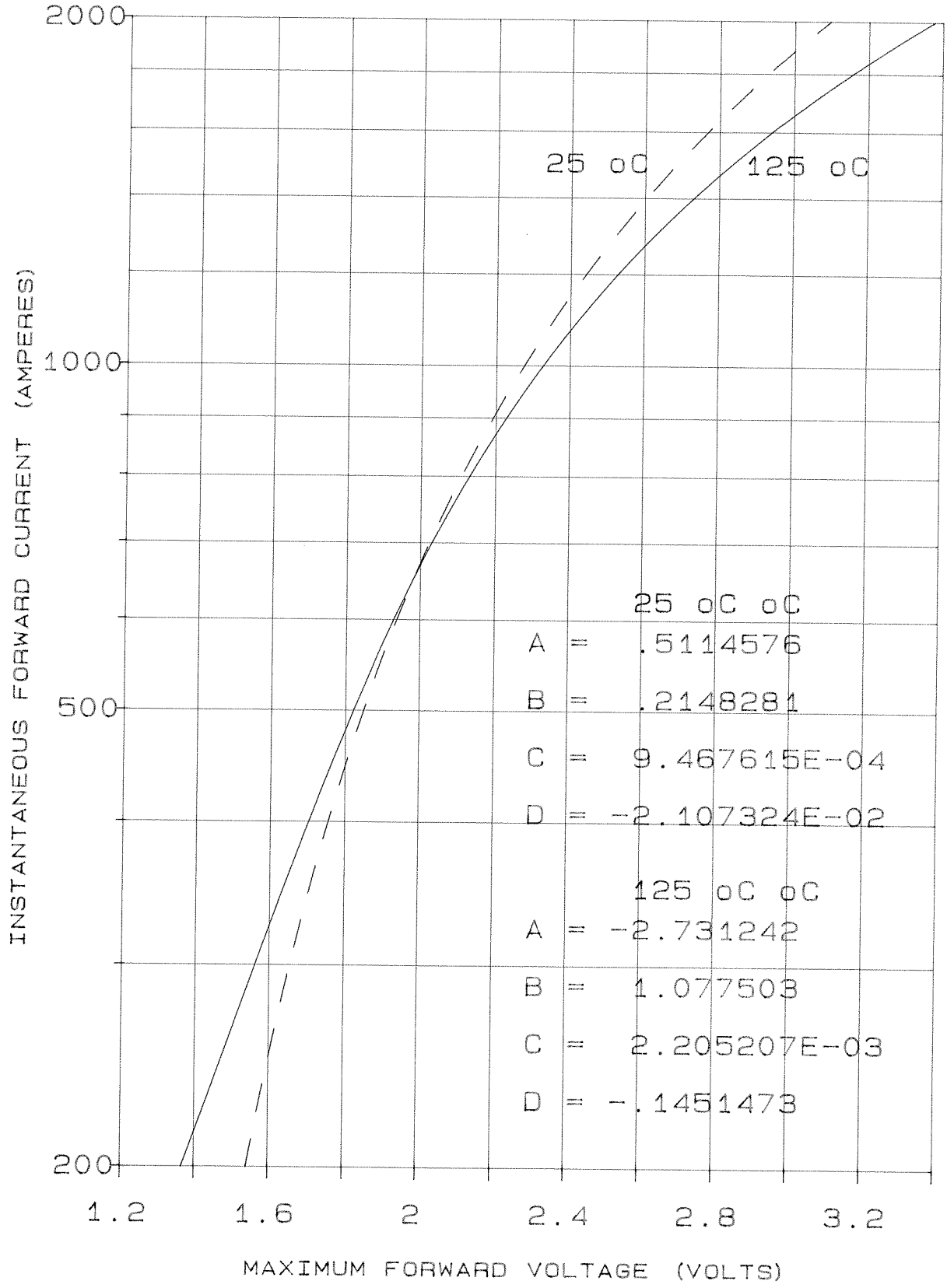
Let E be the value of energy per reverse cycle in joules (curves on page 16).

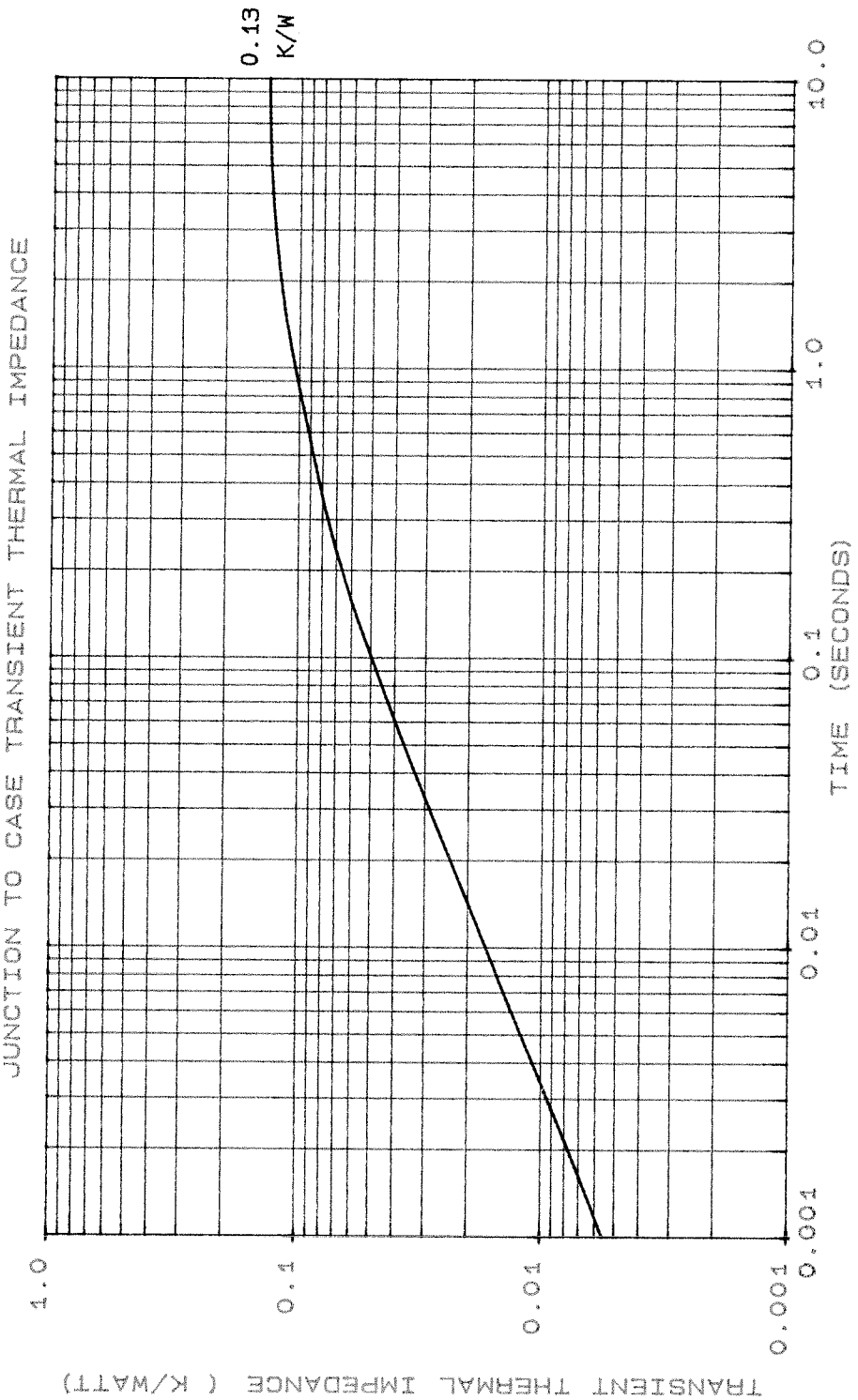
Let f be the operating frequency in Hz

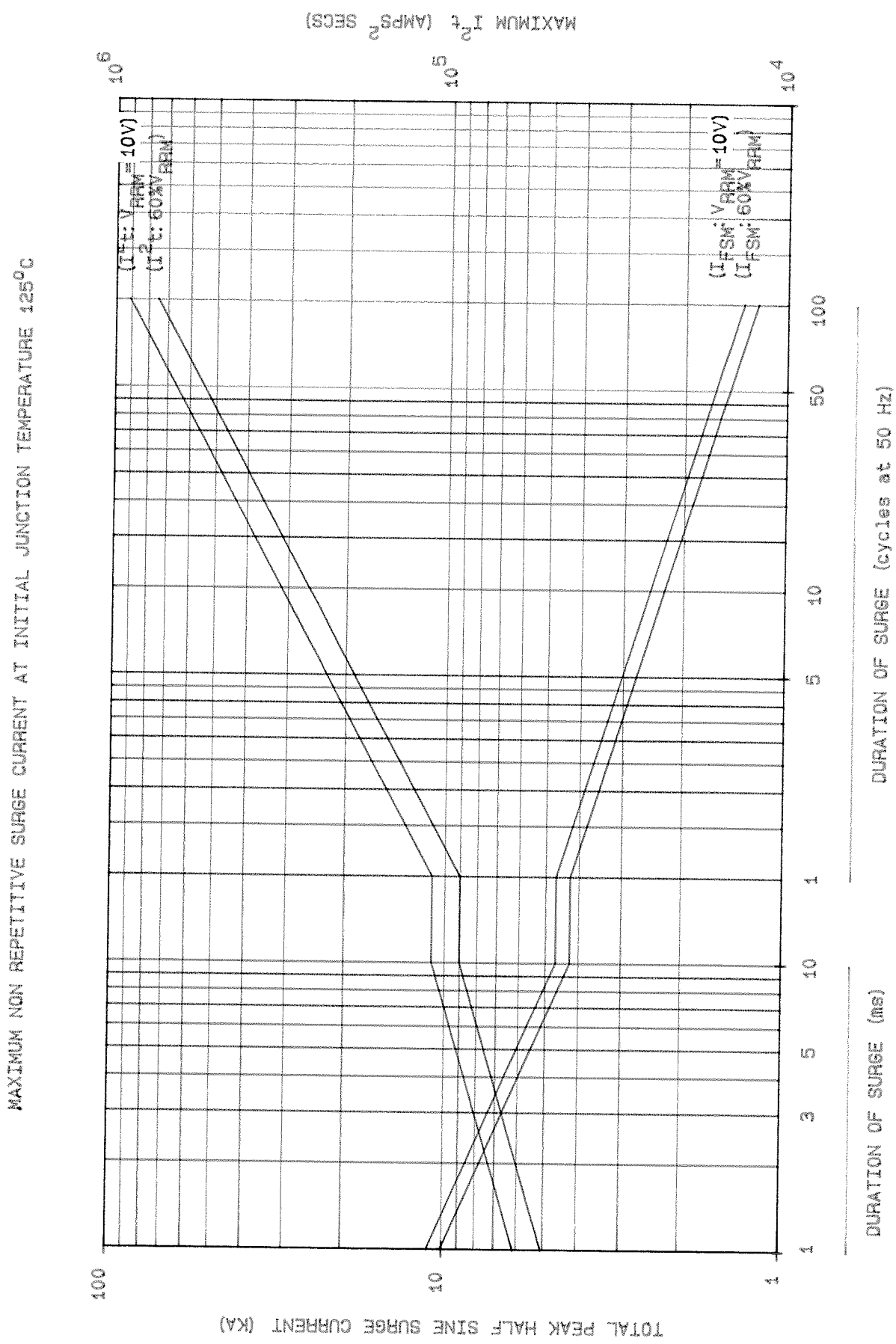
Then $T_{CASE}(new) = T_{CASE}$ original $-E \times R_{th} \times f$

Where $T_{CASE}(new)$ is the required maximum case temperature and T_{CASE} original is the case temperature given with the frequency ratings.

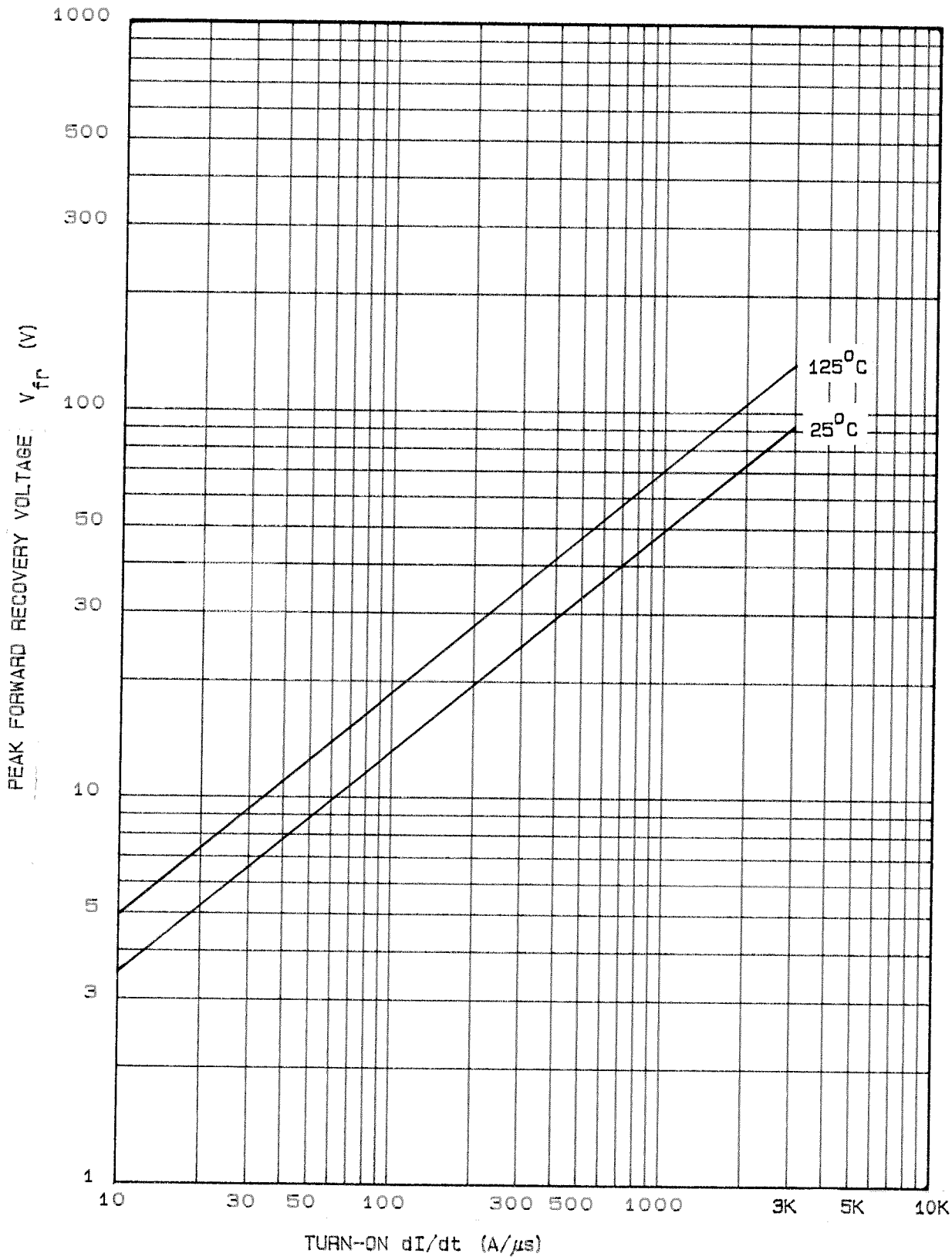
FORWARD CHARACTERISTIC OF LIMIT DEVICE



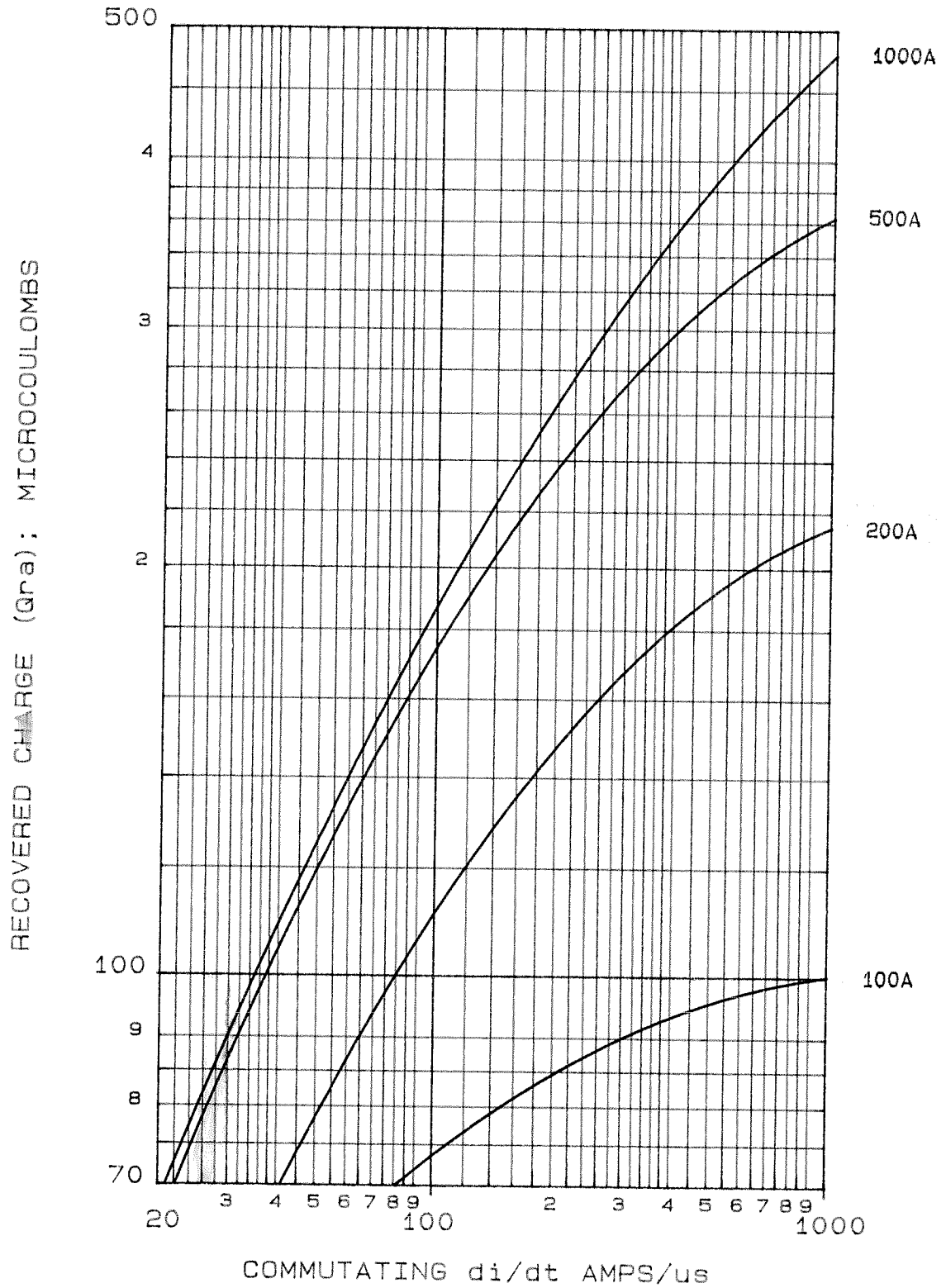

JUNCTION TO CASE TRANSIENT THERMAL IMPEDANCE
0.13
K/W
TRANSIENT THERMAL IMPEDANCE (K/WATT)
1.0
0.1
0.01
0.001
0.0001
0.001
0.01
0.1
1.0
10.0
TIME (SECONDS)


MAXIMUM NON REPETITIVE SURGE CURRENT AT INITIAL JUNCTION TEMPERATURE 125°C
MAXIMUM I²t (AMPS² SECS)
TOTAL PEAK HALF SINE SURGE CURRENT (KA)
DURATION OF SURGE (ms)
DURATION OF SURGE (cycles at 50 Hz)
(Tt: VRRM = 10V)
(I²t: 60%VRRM)
(IFSM: VRRM = 10V)
(IFSM: 60%VRRM)

TYPICAL FORWARD RECOVERY VOLTAGE

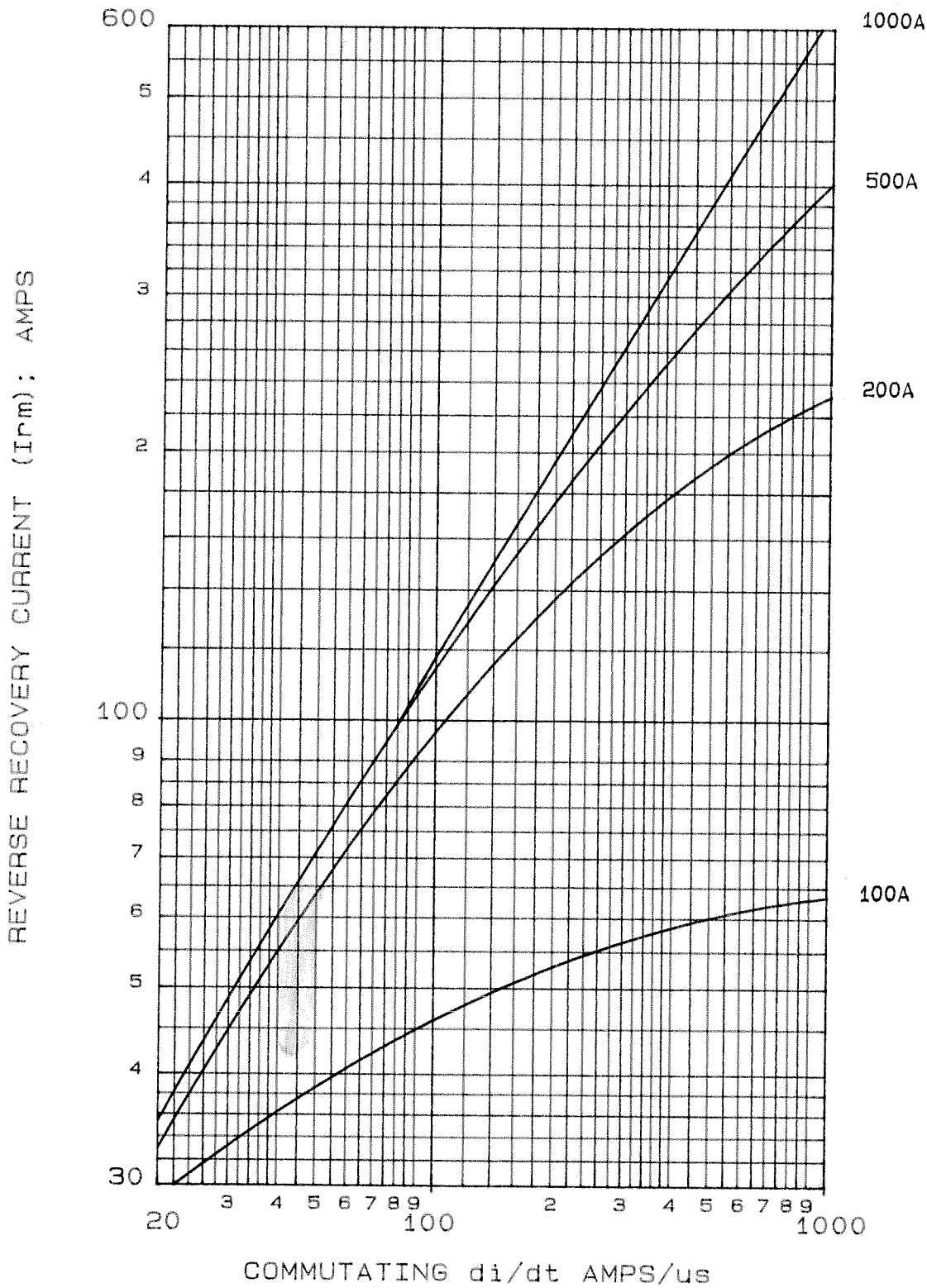


MAXIMUM RECOVERED CHARGE AT 125°C JUNCTION TEMPERATURE



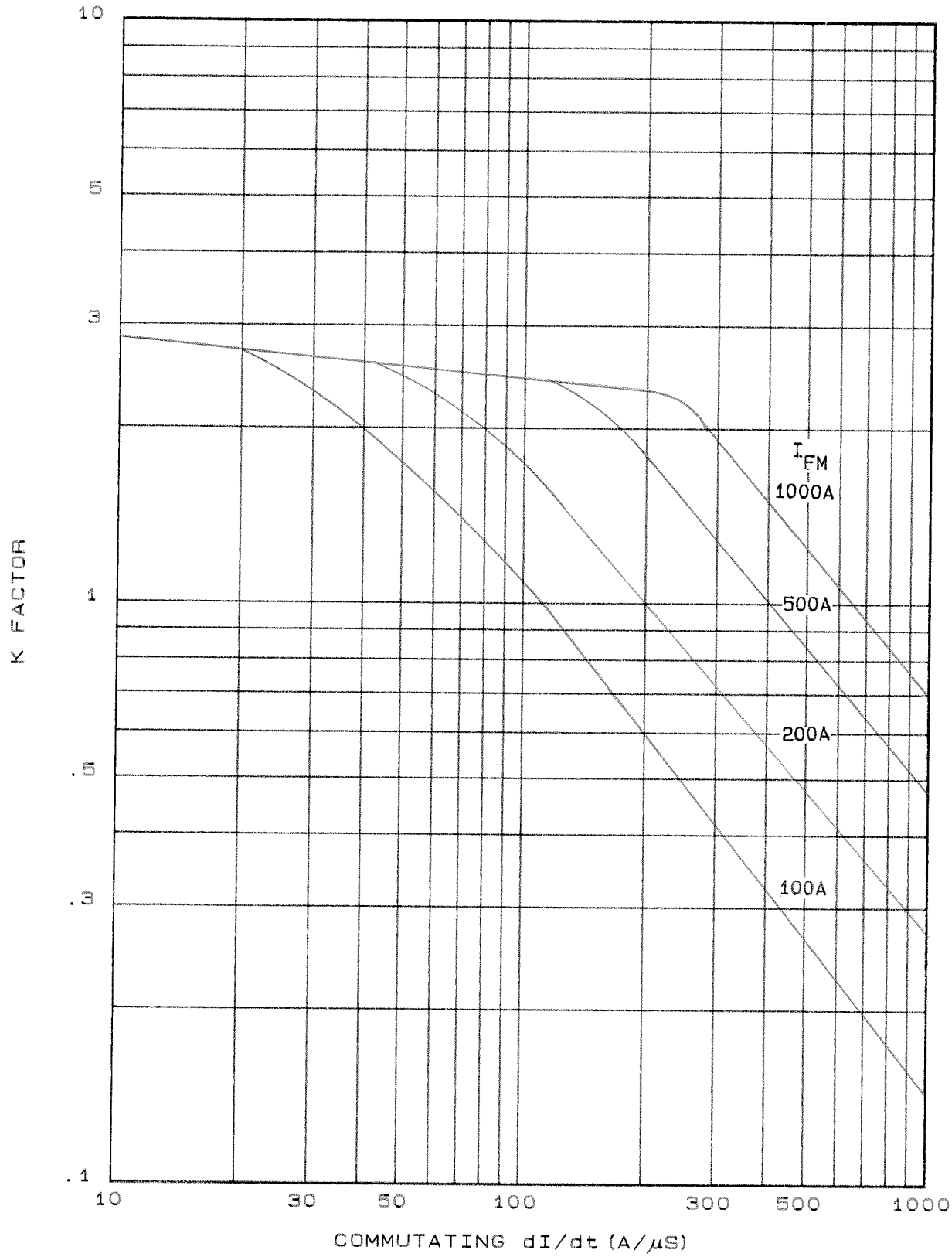
MAXIMUM REVERSE RECOVERY CURRENT

AT 125°C JUNCTION TEMPERATURE

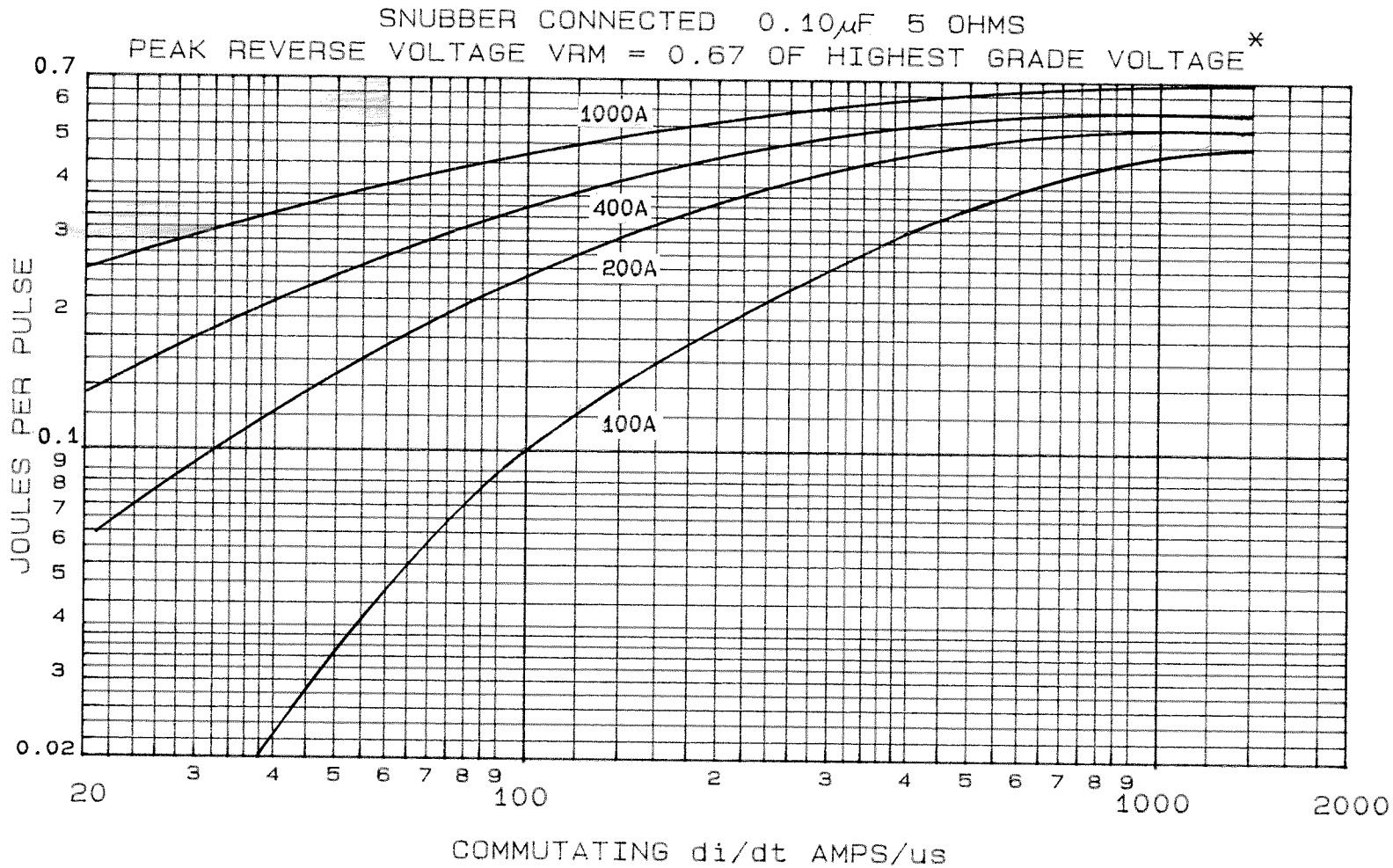


MAXIMUM K FACTOR

T_j = 125°C

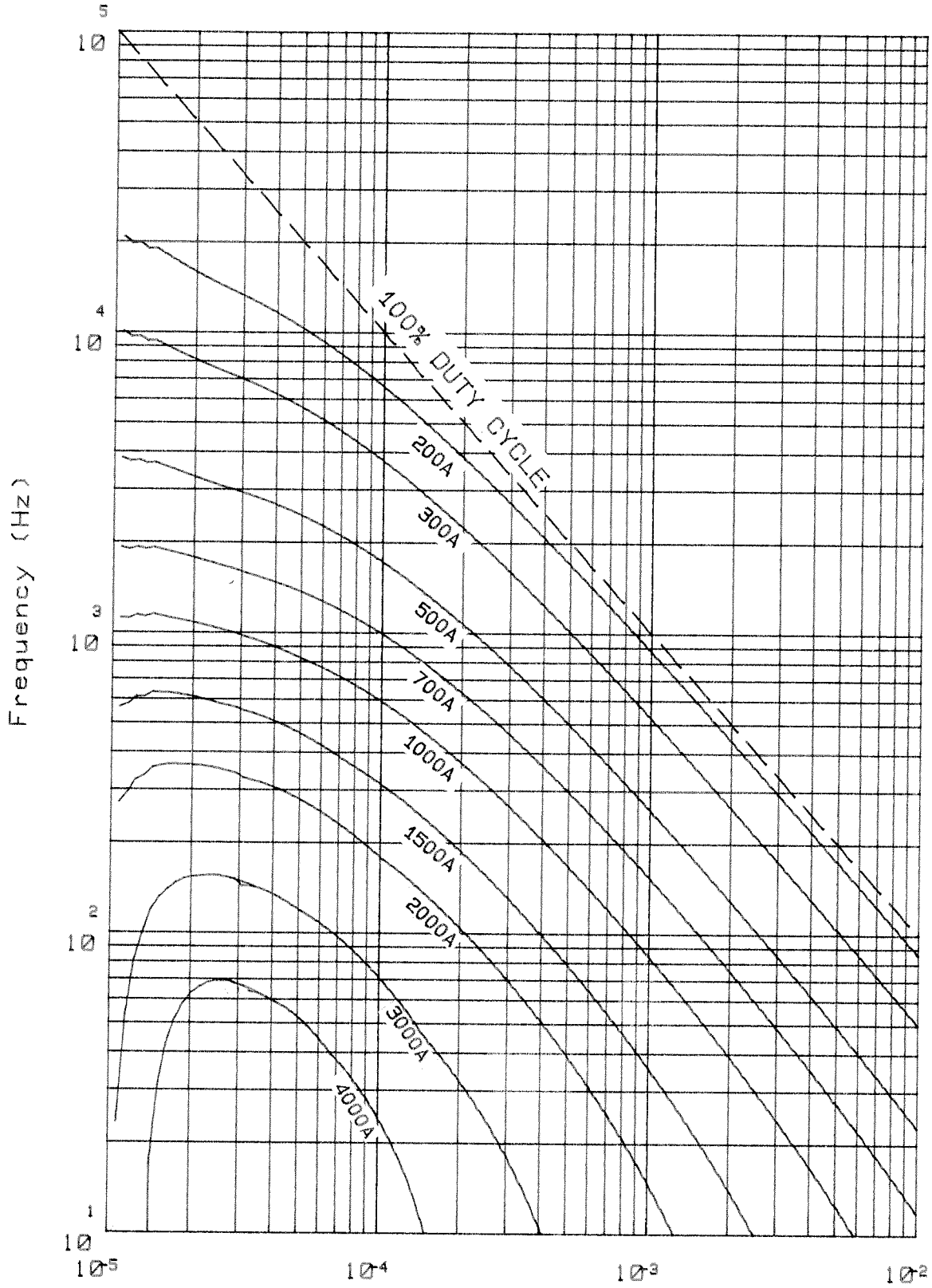


MAXIMUM REVERSE RECOVERY ENERGY LOSS PER PULSE, 125 C JUNCTION TEMPERATURE

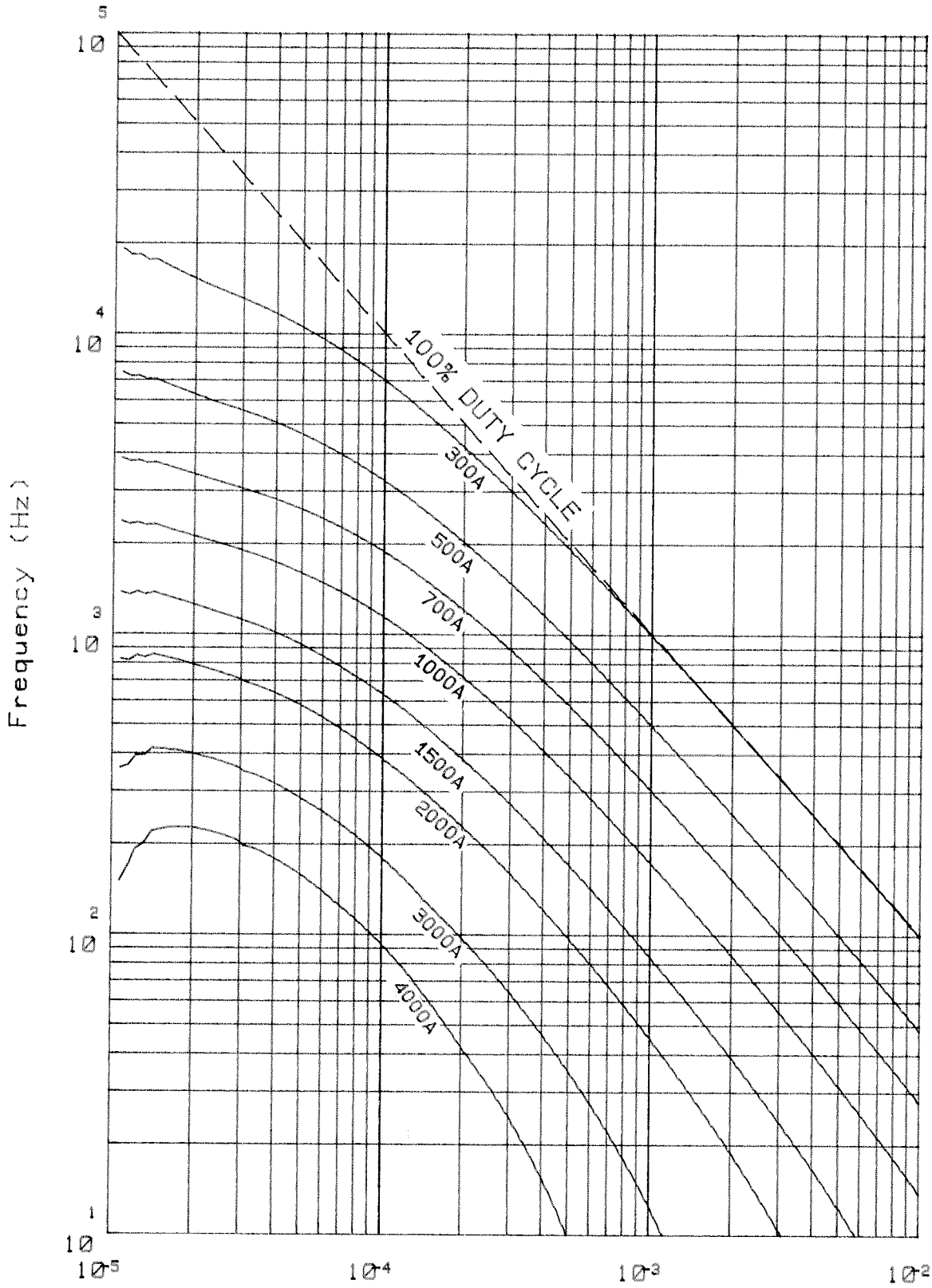


*NOTE: ENERGY PER PULSE SHOULD BE ADJUSTED PRO RATA WITH APPLIED PEAK RECOVERY VOLTAGE

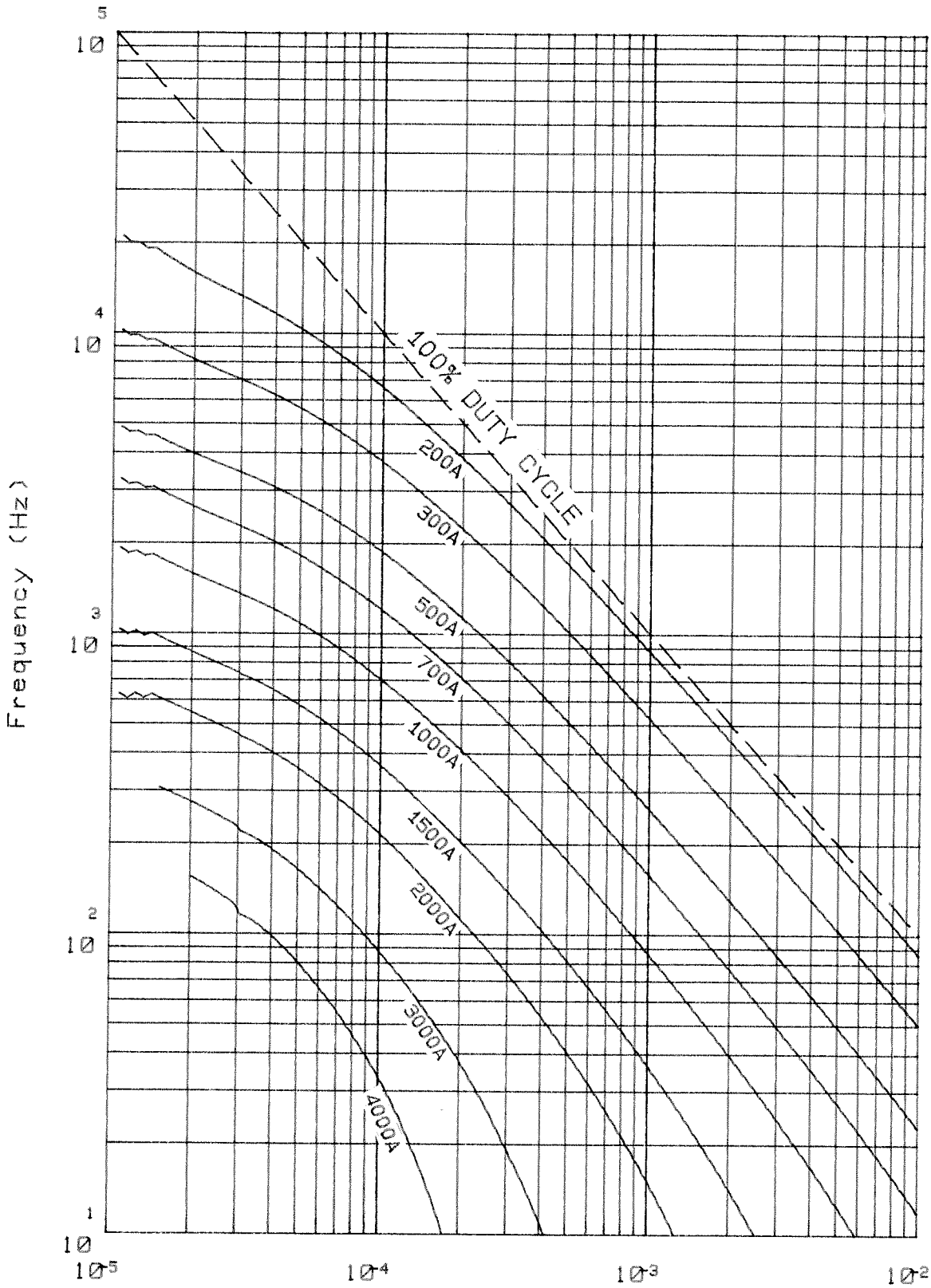
T BASE 90°C 800A/μs



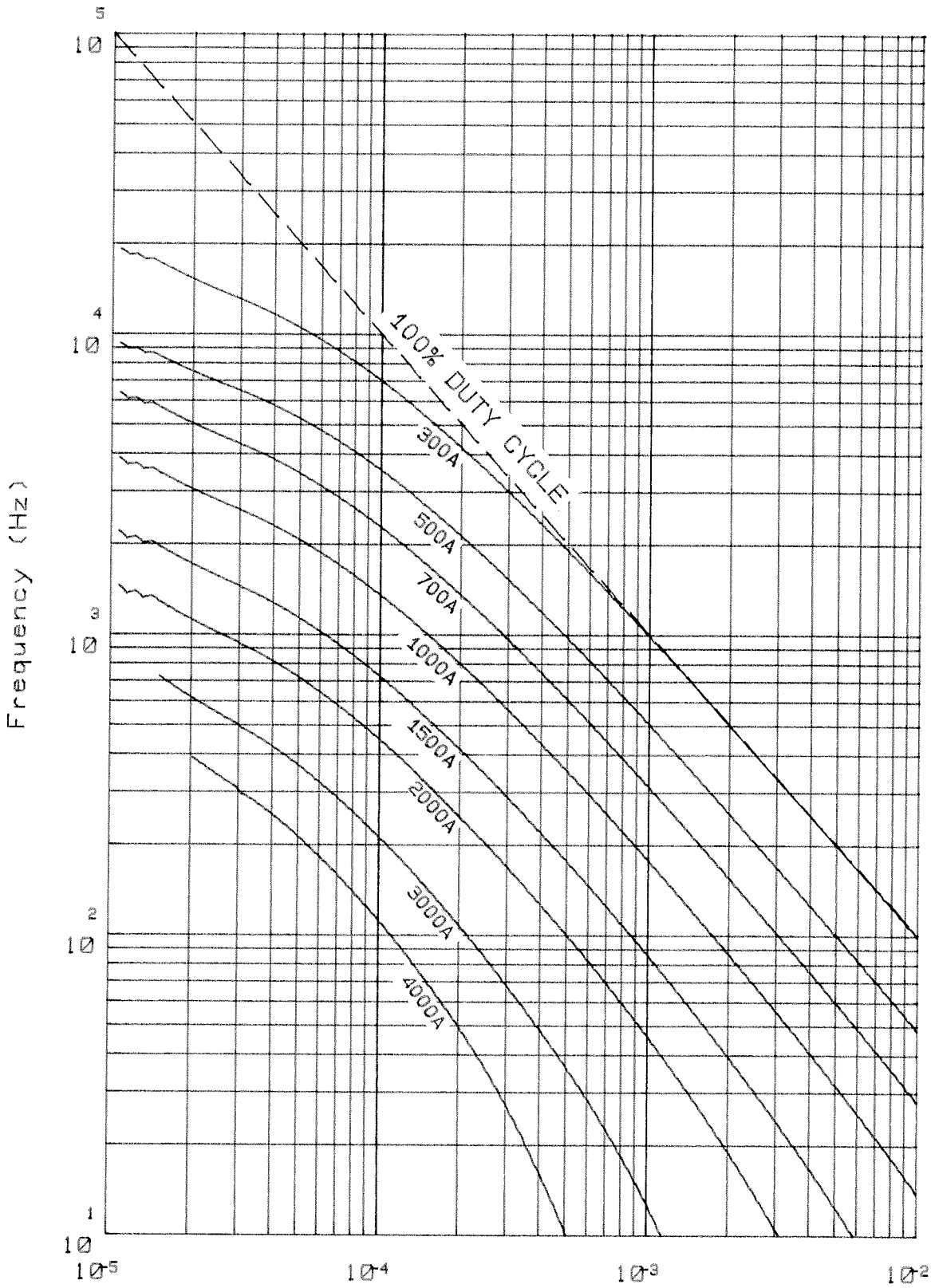
T BASE 60 oC. 800A/μs



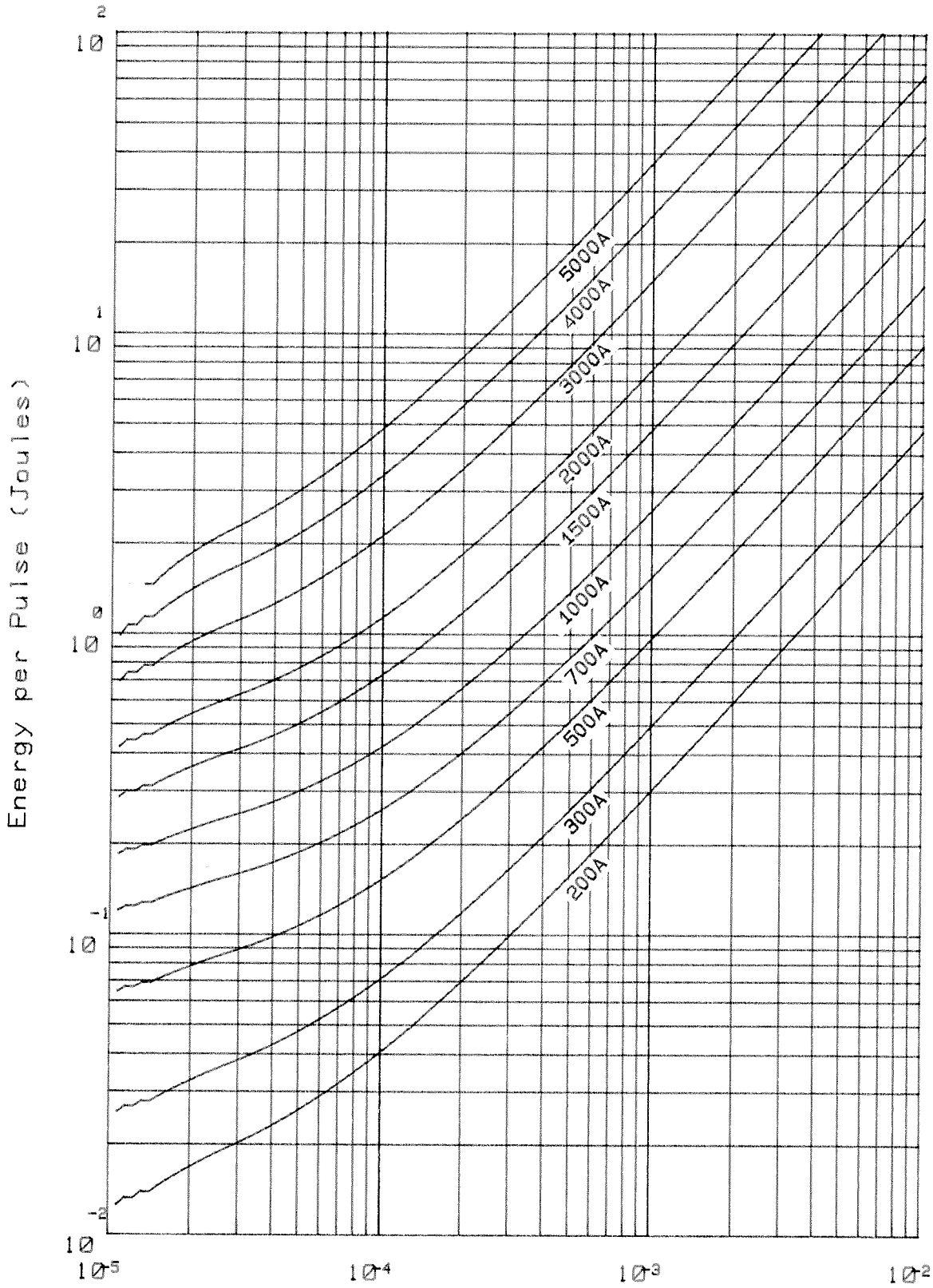
T BASE 90 oC. 400A/μs



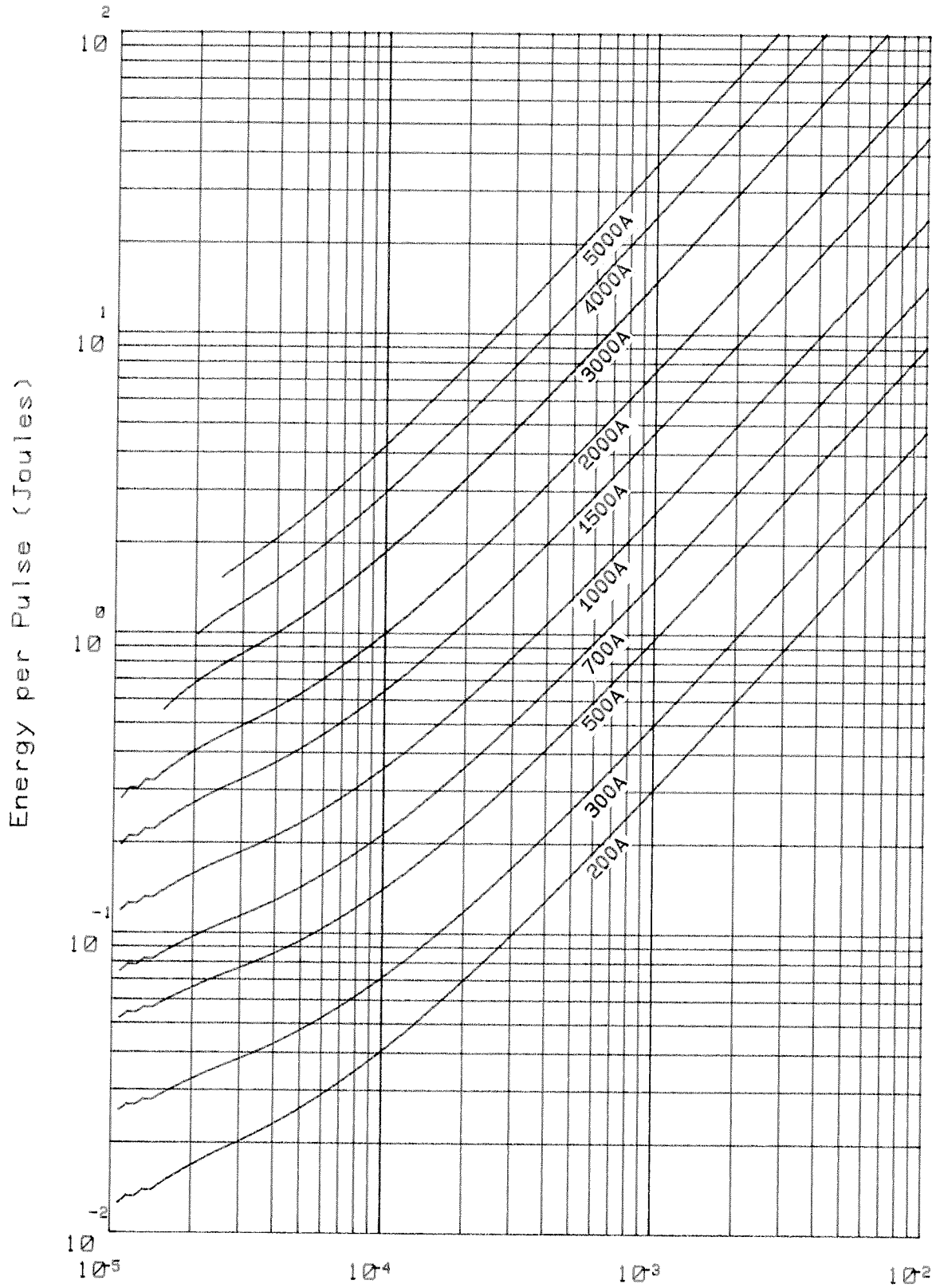
T BASE 60 oC. 400A/μs



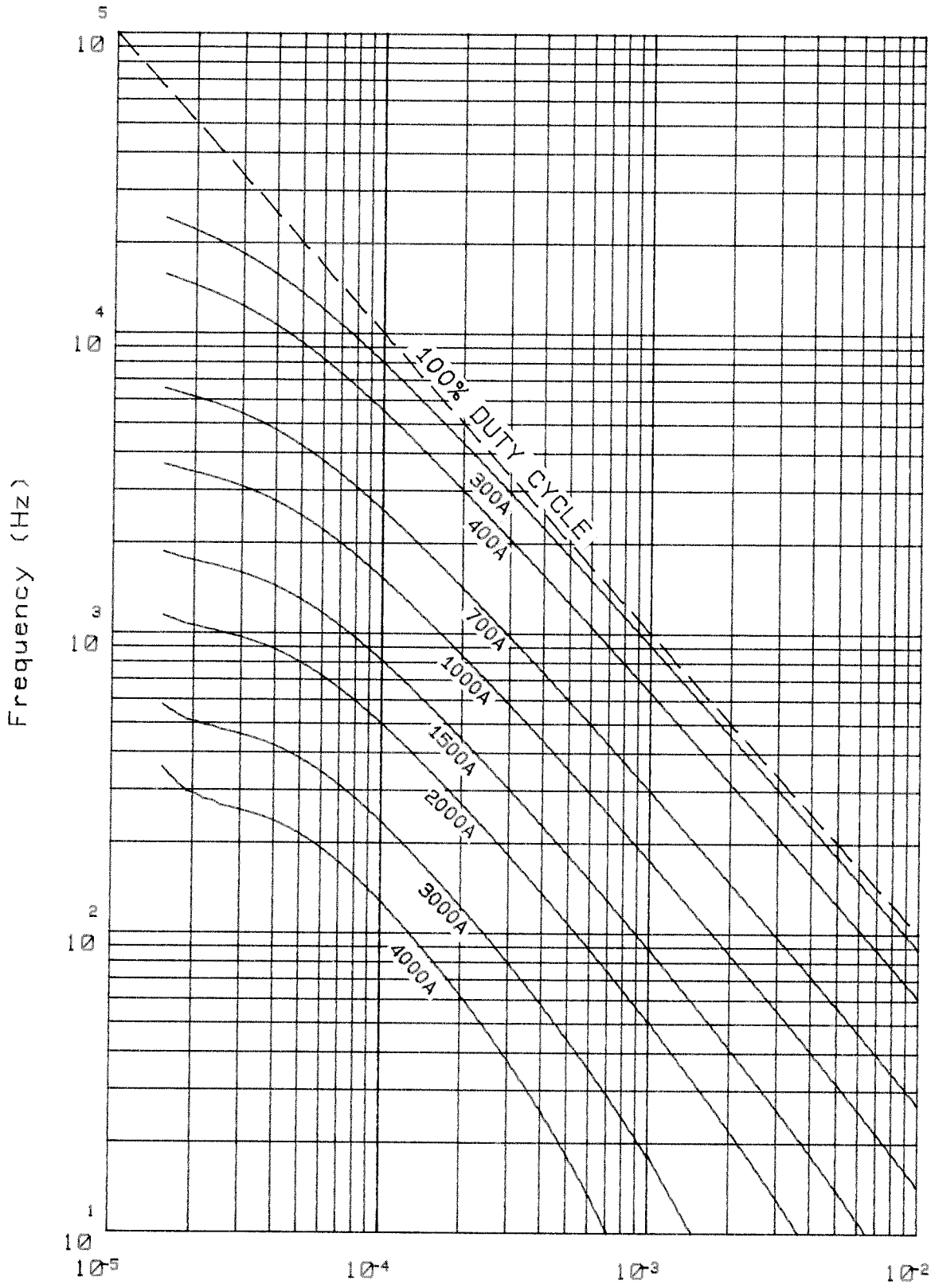
Tj 125 oC. 800A/µs



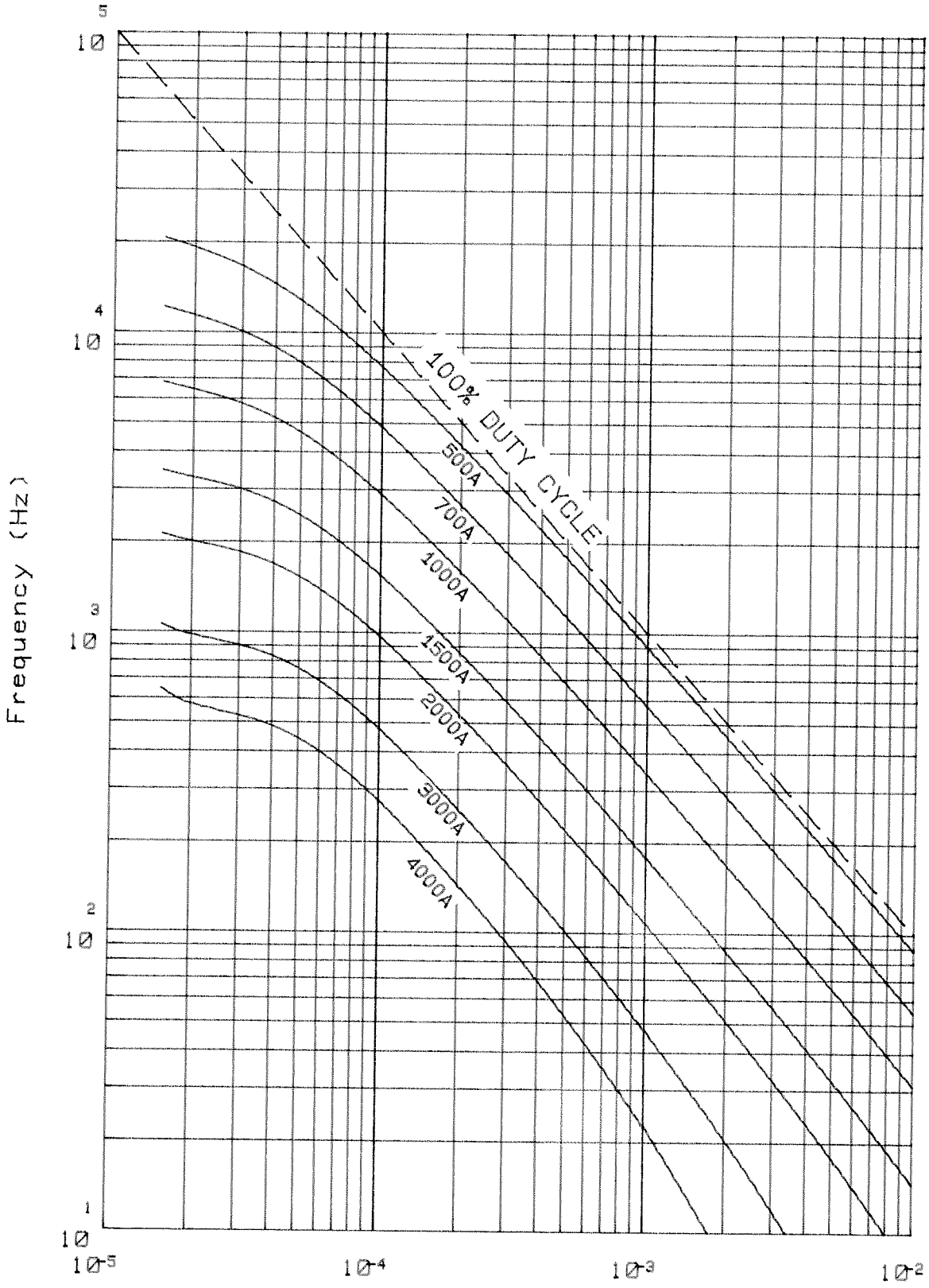
Tj 125 oC. 400A/μs



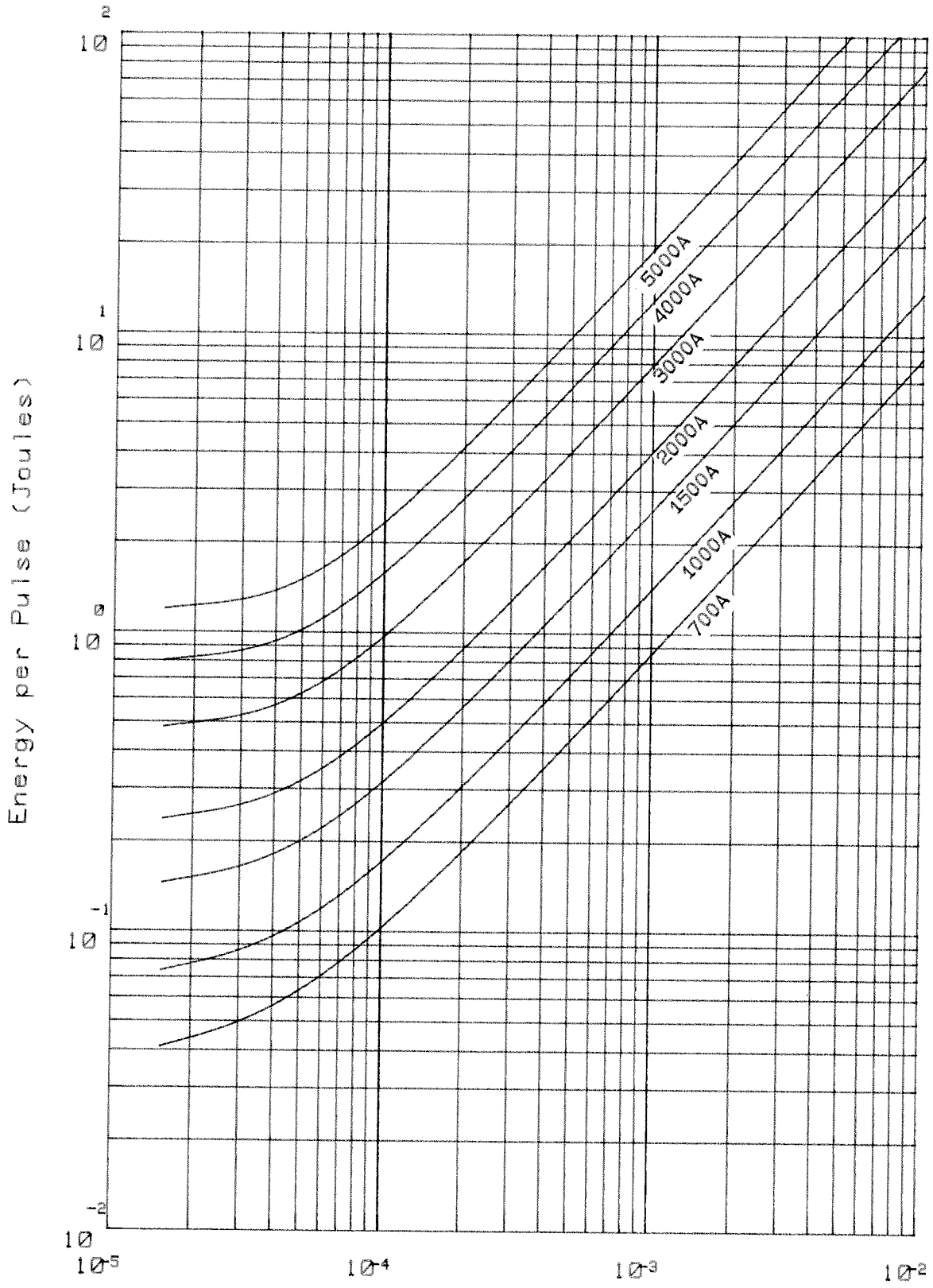
T BASE 90 oC SINE WAVE



T BASE 60 oC SINE WAVE



Tj 125 oC SINE WAVE



SCALE	1/1
DRN	AWF
CHKD	
APPD	
	A
S	NI

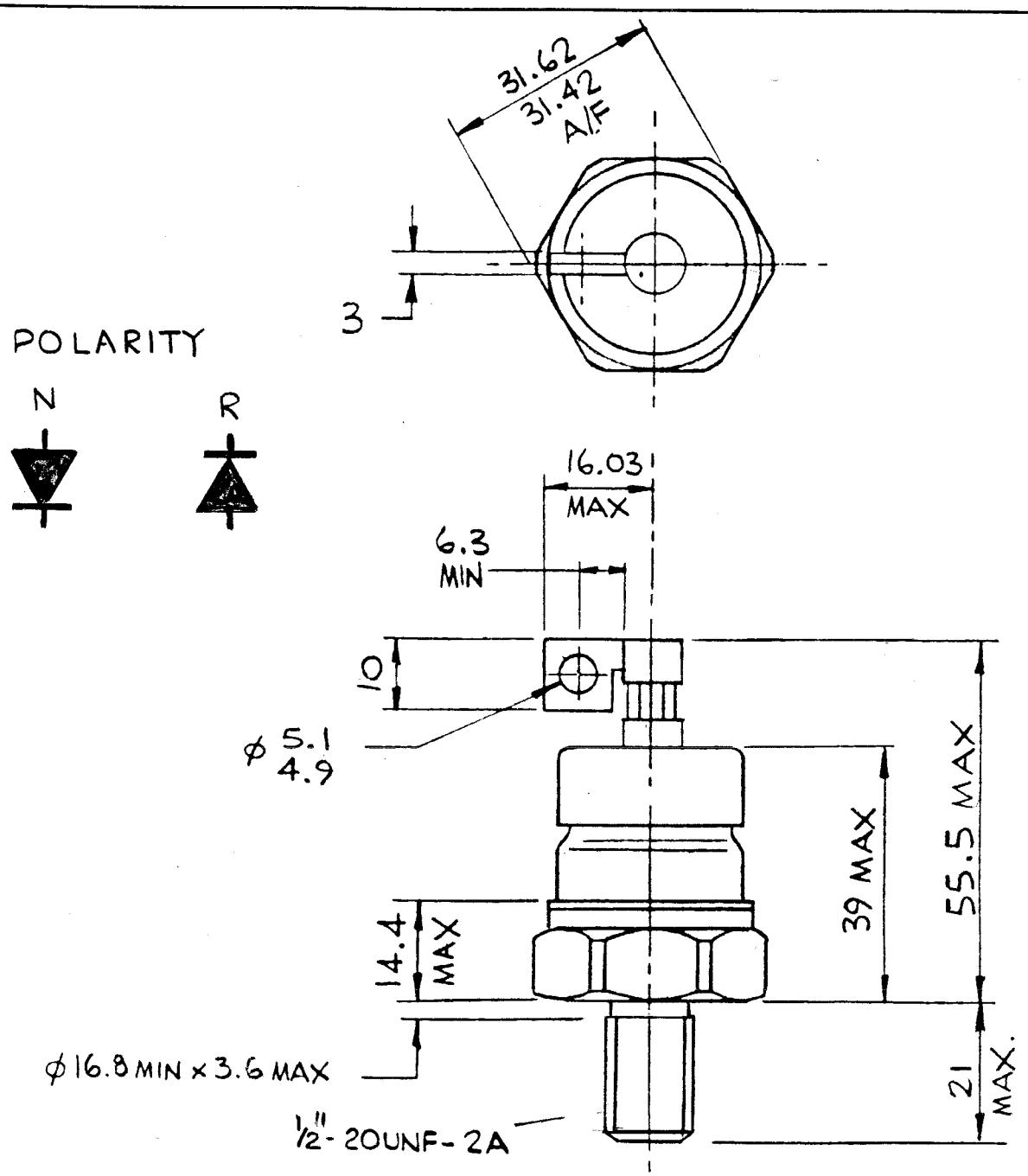
INTERNATIONAL OUTLINE No.
WEIGHT. 200 GRAMS

FINISH. BRIGHT NICKEL PLATE.
DEVICE MARKING INCLUDES MONOGRAM, TYPE No., SPEC. No. AND POLARITY SYMBOL.
DEVICE MOUNTING: MOUNTING TORQUE TO BE 14 Nm (1.45 kgf-m). THREADS MUST NOT BE LUBRICATED.

DIODE TYPE NUMBER
PCN144 PCR144
PCN134 PCR134

Not accepted
Same issue as in
Report 3.

G.A. DRG. No. 102A231N & 102A231R.



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THIRD ANGLE PROJECTION

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DRG. No. 100A297

ISS	REVISIONS
1	28.11.88.
2	9.1.89 ½"-20UNF WAS ¾"-16UNF AWF
3	12.1.89 TYPE No. WAS PRN/R144 AWF
4	24.1.90 TYPE No WAS PRN/R144 U9143 AWF
5	PCN/R134 ADDED. 21.5.90 AWF